

QT-Brightek SMD Display Series

0.40" Dual Digit SMD Display

Part No.: QBDS40ZXX

XX= Color

Z= 1: Common Cathode

Z = 0: Common Anode

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Introduction

Feature:

- 0.40" dual digit seven segments display
- Low power consumption
- Packed in tape & reel
- White segment and grey surface
- XX = color code
- Z=1: Common Cathode or 0: Common Anode

Description:

These 0.40" dual digit seven segments displays are made with white segment and grey surface. The viewing distance is up to seven meters.

Application:

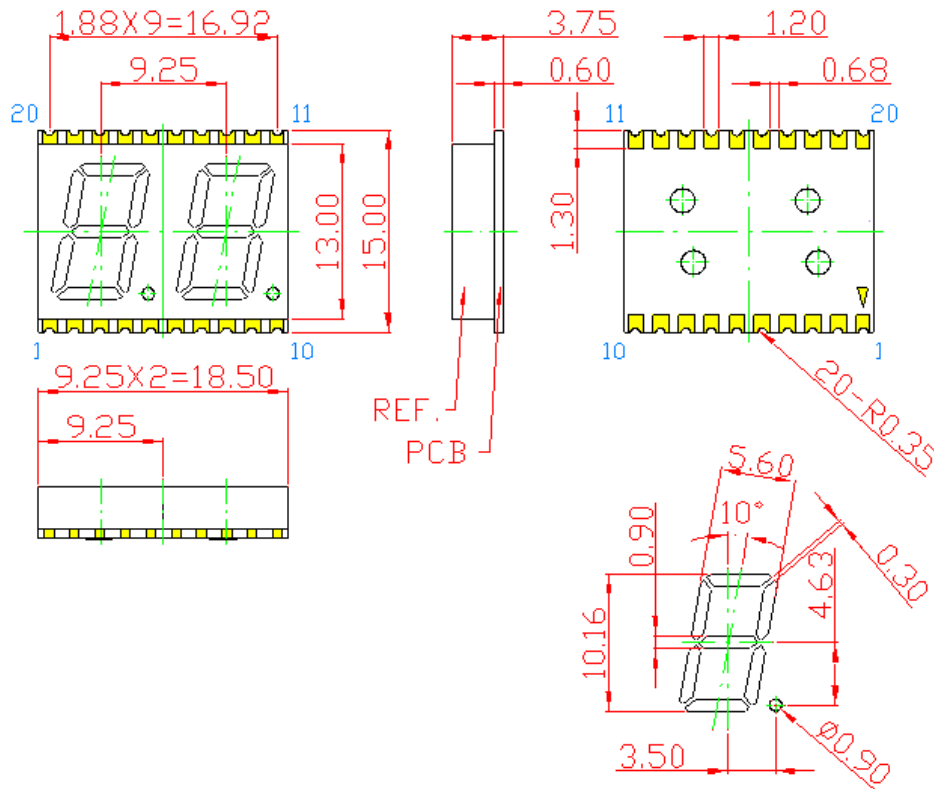
- Instrument panels
- Indoor/Outdoor display board
- Audio equipment

Certification & Compliance:

- TS16949
- ISO9001
- RoHS Compliant



Dimension:



Units: mm / tolerance = +/-0.25mm

Electrical / Optical Characteristic: (Ta=25 °C)

Product		Material	Color	I _F (mA)	V _F (V)		λ _d (nm)			I _V (mcd)
CC	CA				Typ.	Max.	Min.	Typ.	Max.	Typ.
QBDS401R	QBDS400R	AllnGaP	Red	20	2.0	2.6	-	625	-	30
QBDS401S	QBDS400S	AllnGaP	Deep Red	20	2.0	2.6	-	640	-	10
QBDS401Y	QBDS400Y	AllnGaP	Yellow	20	2.0	2.6	-	590	-	20
QBDS401O	QBDS400O	AllnGaP	Orange	20	2.0	2.6	-	610	-	20
QBDS401AG	QBDS400AG	AllnGaP	Yellow Green	20	2.1	2.6	-	571	-	8
QBDS401IG	QBDS400IG	InGaN	True Green	20	2.8	3.8	-	520	-	180
QBDS401IB	QBDS400IB	InGaN	Blue	20	3.1	4.0	-	470	-	60

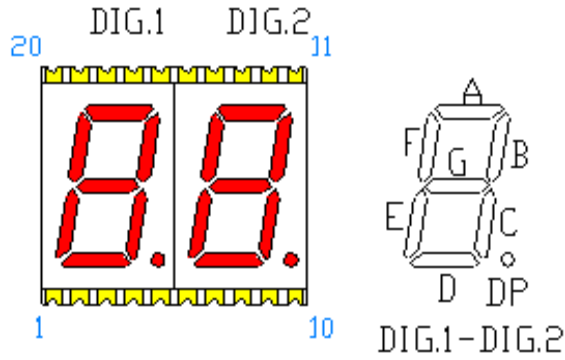
Absolute Maximum Rating

Material	P _d (mW)	Derating linear from 25C per dice (mW/C)	I _F (mA)	I _{FP} (mA)*	V _R (V)	T _{OP} (°C)	T _{ST} (°C)	T _{SOL} (°C)**
AllnGaP	70	0.28	25	90	5	-40 to +105	-40 to +105	260
InGaN	120	0.3	30	100	5	-40 to +105	-40 to +105	260

*Duty 1/10 @ 1KHz

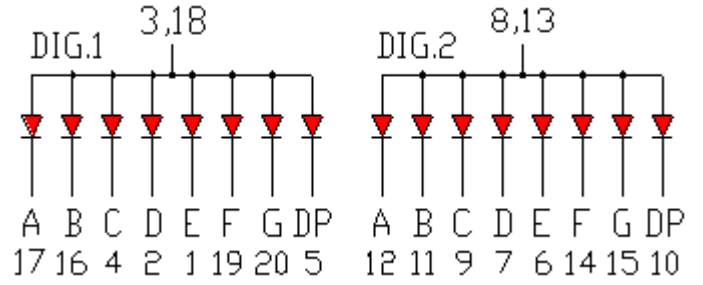
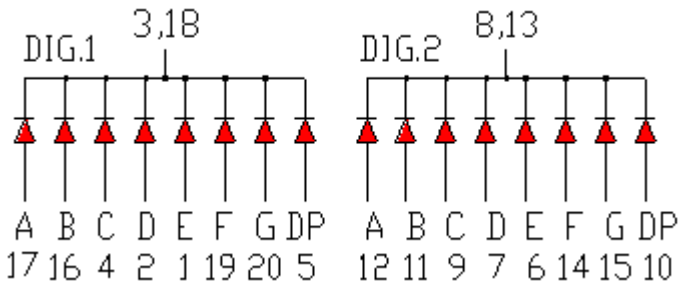
**IR Reflow for no more than 5 sec @ 260 °C

Pin Configuration



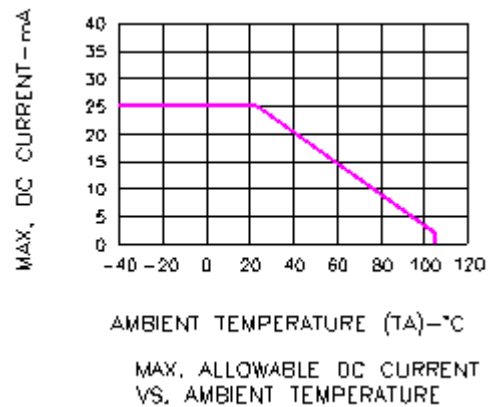
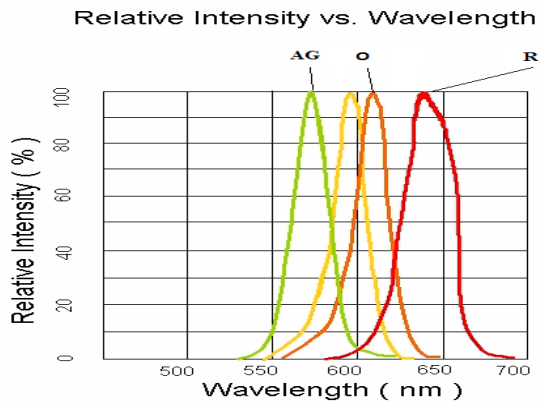
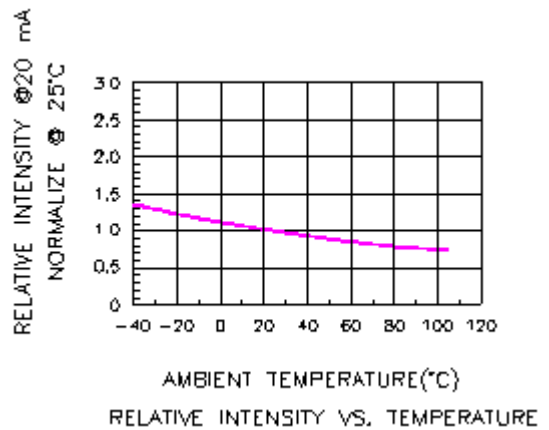
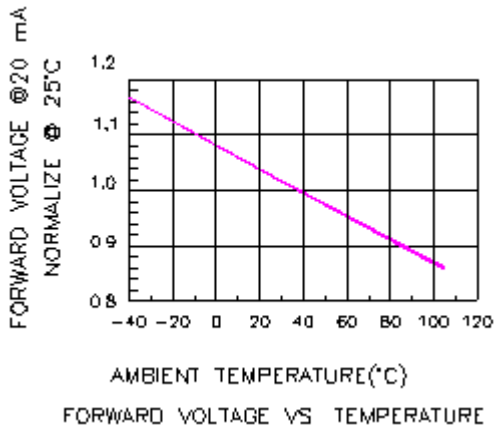
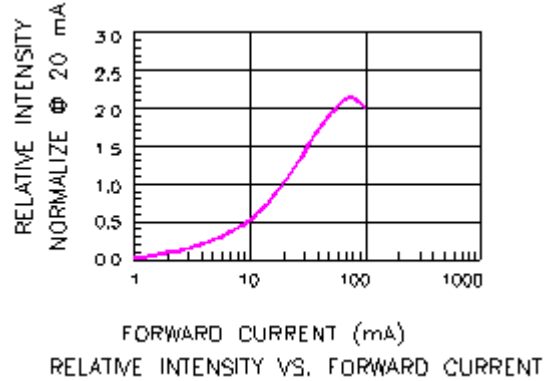
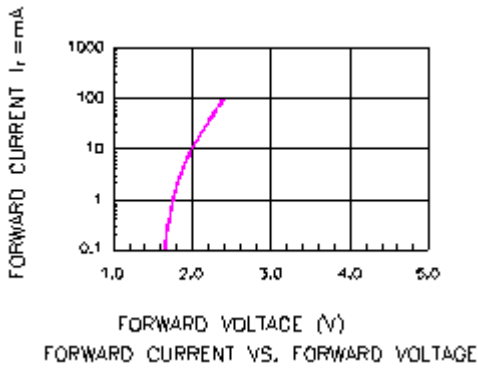
CC

CA



Characteristic Curves

AllnGaP



InGaN

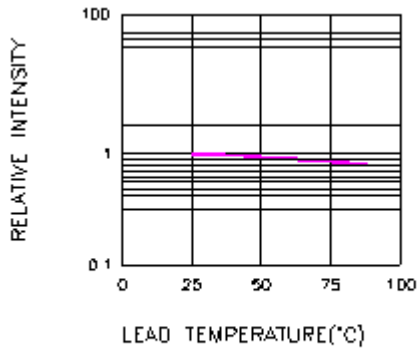
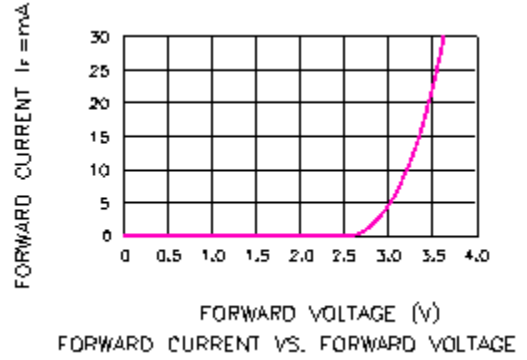
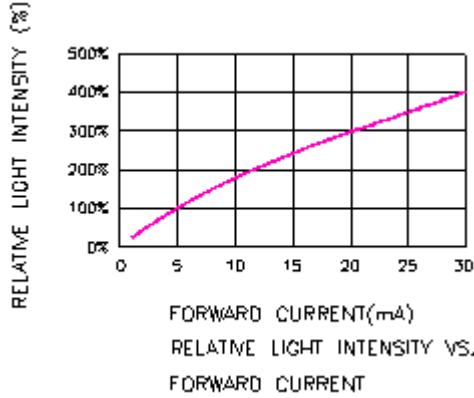


Fig.3 RELATIVE INTENSITY VS.LEAD TEMPERATURE
(PULSED 20 mA; 300us PULSE,10ms PERIOD)

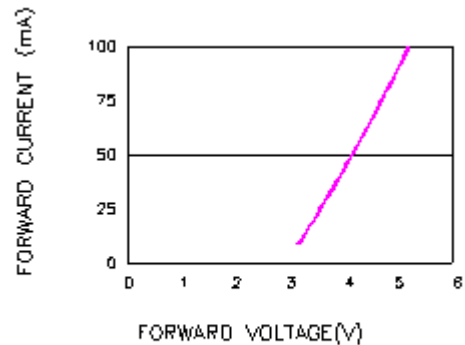


Fig.4 PEAK FORWARD VOLTAGE VS.FORWARD(100us TEST PULSE, 1% DUTY CYCLE)

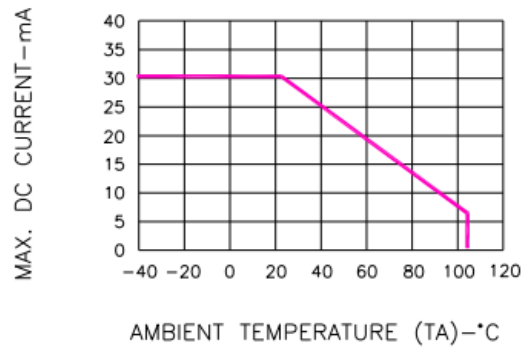
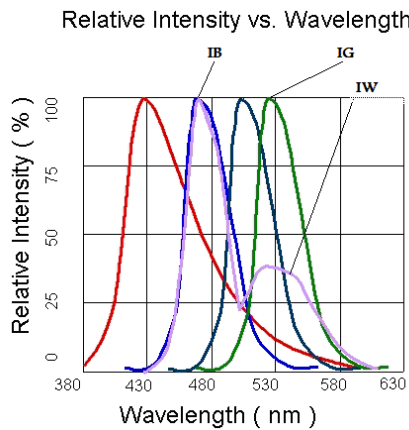
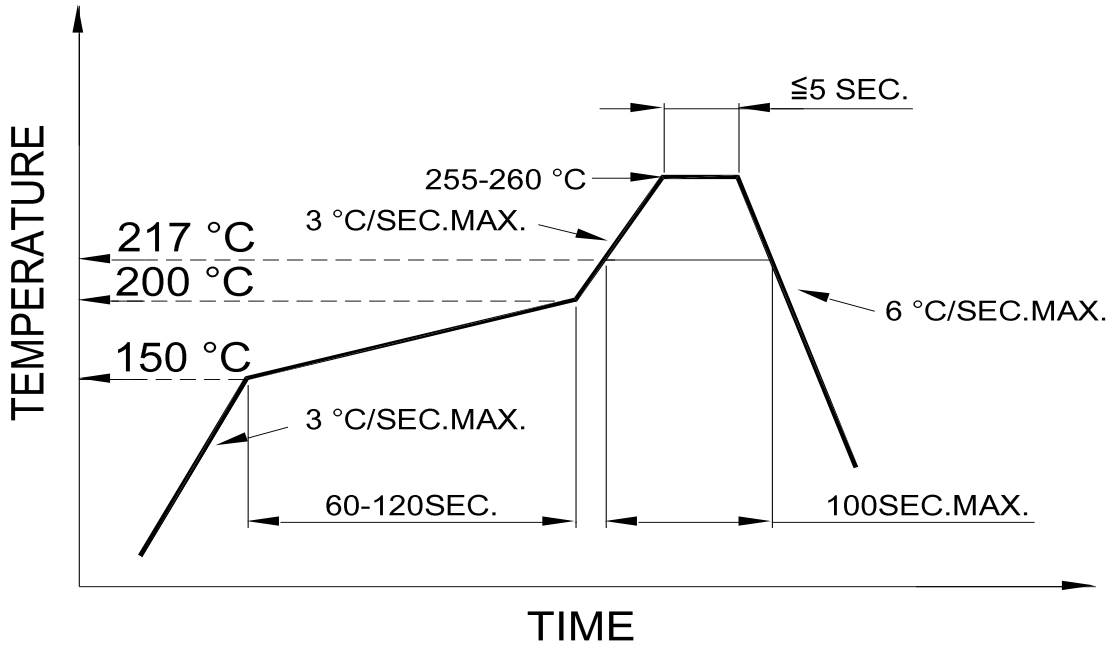


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

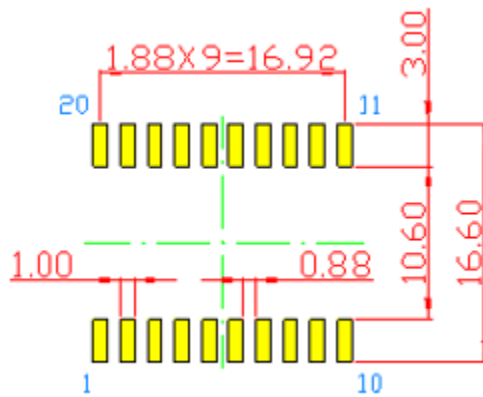
Solder Profile & Footprint

Lead-free Solder Profile:

Pb free reflow soldering Profile



Recommended Pad Layout

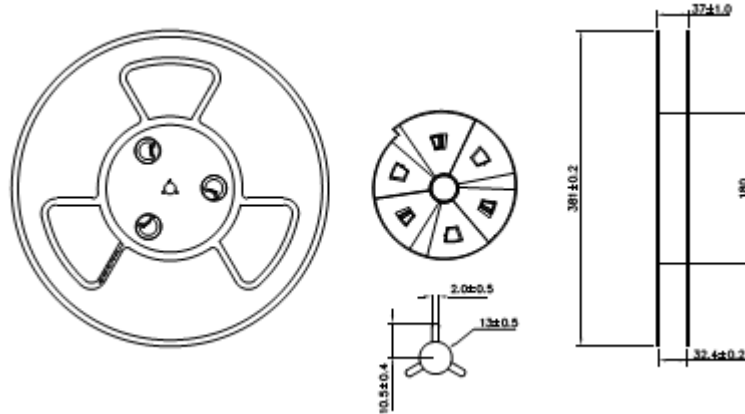


Units: mm

Tolerance: ± 0.25 mm

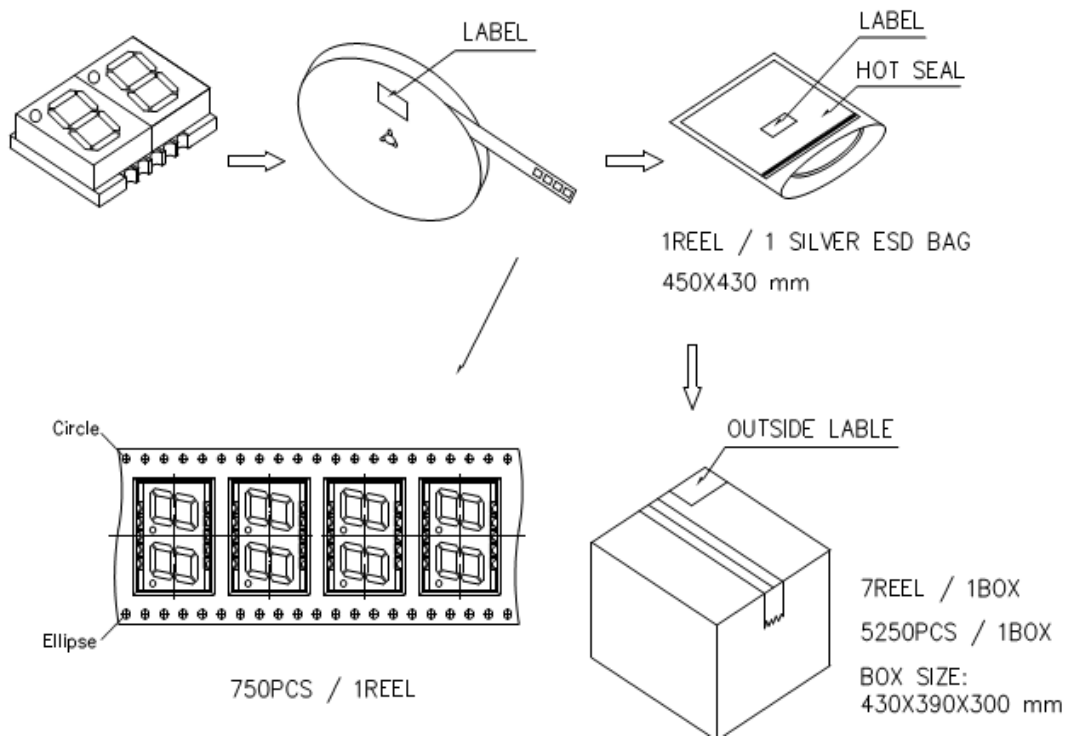
Packing & Labeling

Reel Dimension:



Unit: mm

Packing and Label Specification:



Ordering Information

Product		Orderable Part #		Spec Range	Quantity per Reel
CC	CA	CC	CA		
QBDS401R	QBDS400R	QBDS401R	QBDS400R	I _v =30mcd Typ. @ I _F =20mA, λ _D : 625nm typ.	750
QBDS401S	QBDS400S	QBDS401S	QBDS400S	I _v =10mcd Typ. @ I _F =20mA, λ _D : 640nm typ.	750
QBDS401Y	QBDS400Y	QBDS401Y	QBDS400Y	I _v =20mcd Typ. @ I _F =20mA, λ _D : 590nm typ.	750
QBDS401O	QBDS400O	QBDS401O	QBDS400O	I _v =20mcd Typ. @ I _F =20mA, λ _D : 610nm typ.	750
QBDS401AG	QBDS400AG	QBDS401AG	QBDS400AG	I _v =8mcd Typ. @ I _F =20mA, λ _D : 571nm typ.	750
QBDS401IG	QBDS400IG	QBDS401IG	QBDS400IG	I _v =180mcd Typ. @ I _F =20mA, λ _D : 520nm typ.	750
QBDS401IB	QBDS400IB	QBDS401IB	QBDS400IB	I _v =60mcd Typ. @ I _F =20mA, λ _D : 470nm typ.	750

Revision History

Description:	Revision #	Revision Date
New Release of QBDS40ZXX	V1.0	03/25/2014
Add more colors, update drawing dimension	V1.1	10/30/2015

Disclaimer

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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